

Statement of Compliance

Requested Part

3-6 (Part 1 of 1)
284513-6
6 POS TERMI-BLOK HDR 900 POL.
Active
No
Not Compliant Substances: Pb

This declaration covers EU Directive 2011/65/EU incl. Delegated Directive 2015/863/EU.

EU ELV Directive: 2000/53/EC	Compliant with Exemptions 3 - Lead in copper alloy containing up to 4% lead by weight.
China RoHS 2 Directive: MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation: (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2023 (233) Candidate List Declared Against: JAN 2023 (233) SVHC > Threshold: Pb (.8% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content:	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability Code:	Wave solder capable to 240°C

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This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Restricted Materials Above Threshold

12 June 2023

SI)

中国电子电气产品中有害物质的名称及含量

China EEP Hazardous Substance Information

部件名称		有害物质						
(Component Name)		Hazardous Substance						
284513-6	铅	汞	镉	六价铬	多溴联苯	多溴二苯醚		
	(Pb)	(Hg)	(Cd)	(Cr6)	(PBB)	(PBDE)		
连接器系统	x	0	0	0	0	0		
(Connector Systems)								
					限量要求以下。 eous materials			
	如在这部件所有均应 the concentration o							
Indicates that t		f the hazardou	is substance ir					
Indicates that t below the relev	the concentration o	f the hazardou ⊫e GB/T 26572	us substance ir standard.	n all homogen	eous materials	of the part is		
Indicates that t below the relev X: 表示该有害物质	the concentration o vant threshold of th	f the hazardou le GB/T 26572 t一均质材料中	us substance ir standard. 的含量超出GE	n all homogen 8/T 26572标准	eous materials 规定的限量要习	of the part is 能。		

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